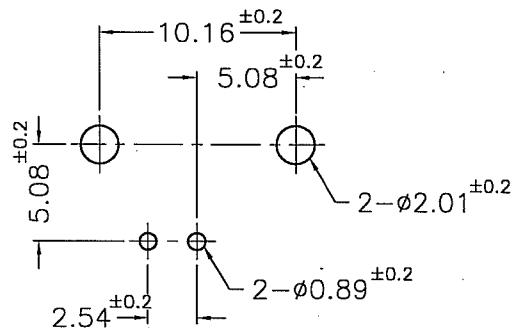
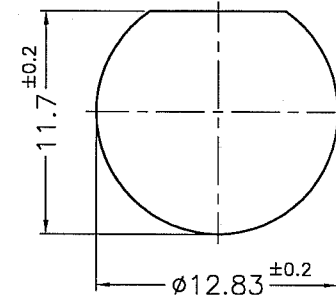


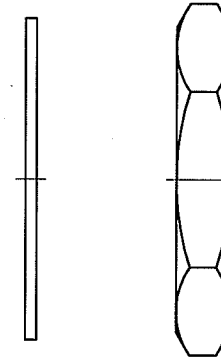
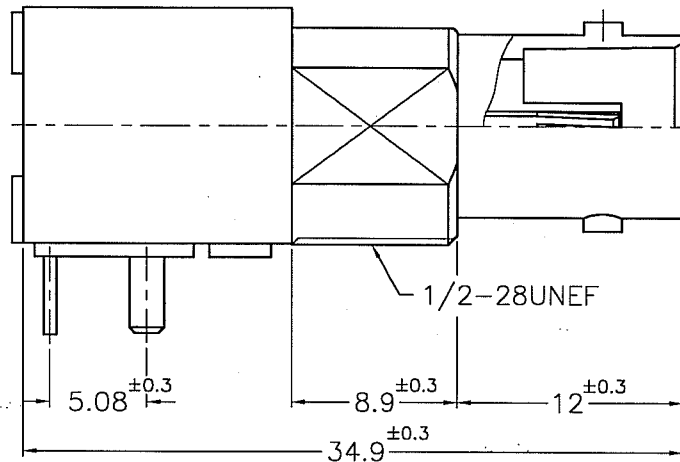
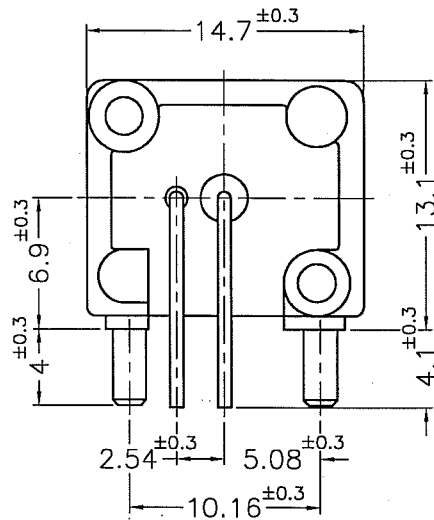
REVISIONS		
ISS	ZONE	DESCRIPTION\PER REQUEST\DATE
A1	C-2	DIMENSIONS WERE CHANGED\N/A\03-14-01'
A2	ALL	DIMENSIONS WERE CHANGED\N/A\07-06-01'
A3	ALL	DIMENSIONS WERE CHANGED\N/A\05-03-02'
A4	B-1	NOTE 5 WAS CHANGED\RD-DM92111701E\11-17-03'
B	B-1	NOTE 5 WAS CHANGED\RD-DM06111701A\03-27-06'



PCB MOUNTING HOLE
(印刷電路板架設孔)



RECOMMENDED MOUNTING HOLE
(建議架設孔)



NOTES: FINISH (PLATING THICKNESS IN MICRO-INCHES)

- BRASS PER QQ-B-626
- NICKEL PL. 80 MIN. THICK OVER COPPER STRIKE
- NICKEL PL. 100 MIN. THICK OVER ZINC ALLOY
- PHOSPHOR BRONZE PER QQ-B-750
- GOLD PL. 3 MIN. THICK OVER NICKEL PL. 100 MIN. THICK OVER COPPER STRIKE AT MATING AREA. TIN PL. 100 MIN. THICK AT TAIL.
- ZINC DIECAST
- POLYPROPYLENE UL 94HB
- TIN PLATING

1. MAX. PANEL THICKNESS=5mm

NO.	DESCRIPTION	MATERIAL	FINISH	Q'TY	DRAWING NO.
	HEX NUT	NOTE 1	NOTE 2		
	LOCK WASHER	S50C	NOTE 2		
	MOUNTING POST	NOTE 1	NOTE 8		
	POST	COPPER	NOTE 8		
	CONTACT PIN	NOTE 4	NOTE 5		
	INSULATOR	NOTE 7	NATURAL		
	BODY	NOTE 6	NOTE 3		

DIMENSIONS ARE IN MILLIMETERS.				PART NO.	
UNLESS OTHERWISE SPECIFIED TOLERANCES				APPROVED <i>[Signature]</i> DATE 03-27-06'	
0.5-6	=	±0.2	CHECKED <i>[Signature]</i> DATE 03-27-06'		
6-30	=	±0.4	DRAWN <i>[Signature]</i> DATE 03-27-06'		
30-120	=	±0.6	FILE NO. F:\DWG\B\6252HB\75T\NPP3G-BSZ		
120-315	=	±1			
315-1000	=	±1.6			
1000-2000	=	±2.4			

Amphenol	
Danbury, CT, USA - Tainan, Taiwan - Shenzhen, China	
TITLE BNC R/A PCB MOUNT RECEPT. JACK	
DRAWING NO. B6252HB-NPP3G-75T	
ITEM NO. 016252AAF07MBOF	

RD-DR 20349 B